Thermal TG1200LB

LDS A1 2025.03



Thermal TG1200LB

Thermal TG1200LB

Features

- High Thermal Conductivity
- Low Compression Stress
- High Reliability
- Automatic Dispensing

	Typical Value	Unit	Test Method
[redacted]			
	Silicone Filled with		
Composition			

Applications

- Consumer Electronics
- Communication Equipment
- Power Supply Controller
- Smart Wearable Product

	25	**g/min**	**30cc ED,9Psi**
Density	**3 25**	**g/cm ³**	**ASTM D2**
Temperature Range	-40 - 150	°C	—
Breakdown Voltage	>= 5	KV/mm	ASTM D149
Volume Resistivity	10^{13}		ASTM D257
Flame Rating	V-0	—	UL 94

All technical information stated in this technical data have been confirmed that all the technical parameters are reliable after harsh testing and evaluation of the products. Before you use our products, please carefully evaluate and decide whether the product meets your requirement and you need to take all the risks and responsibilities to use.